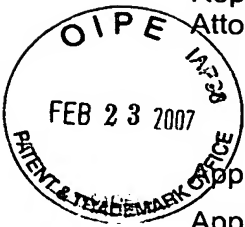


Appl. No. 10/525,996
Amdt. dated February 20, 2007
Reply to Office Action of October 20, 2006
Attorney Docket No. 1217-050618



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/525,996 Confirmation No. 6221
Applicants : Hideo SENOO et al.
Filed : February 28, 2005
Title : Semiconductor Wafer Protection Structure and Laminated
Protective Sheet for Use Therein
Art Unit : 2811
Examiner : Cuong Q. Nguyen
Customer No. : 28289

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action of October 20, 2006, Applicants submit the following amendments and remarks along with a one-month Petition for Extension of Time and requisite fee.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 5 of this paper.

Remarks begin on page 9 of this paper.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on February 20, 2007.

Diane Paull

(Name of Person Mailing Paper)

Diane Paull
Signature

02/20/2007
Date